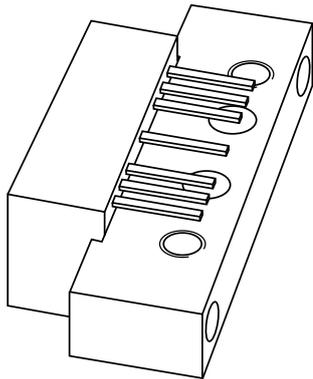


DATA SHEET



BGY1085A

1 000 MHz, 18.5 dB gain push-pull
amplifier

Product specification
Supersedes data of 1997 Apr 15

2001 Oct 25



1 000 MHz, 18.5 dB gain push-pull amplifier

BGY1085A

FEATURES

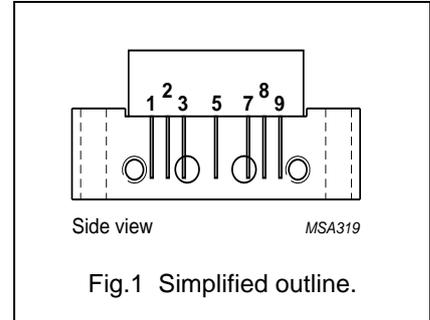
- Excellent linearity
- Extremely low noise
- Silicon nitride passivation
- Rugged construction
- Gold metallization ensures excellent reliability.

DESCRIPTION

Hybrid high amplifier module for CATV systems operating over a frequency range of 40 to 1 000 MHz at a supply voltage of +24 V (DC).

PINNING - SOT115J

PIN	DESCRIPTION
1	input
2	common
3	common
5	+V _B
7	common
8	common
9	output



QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
G _p	power gain	f = 50 MHz	18	19	dB
		f = 1 000 MHz	18.5	–	dB
I _{tot}	total current consumption (DC)	V _B = 24 V	–	240	mA

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	MIN.	MAX.	UNIT
V _i	RF input voltage	–	65	dBmV
T _{stg}	storage temperature	–40	+100	°C
T _{mb}	operating mounting base temperature	–20	+100	°C

1 000 MHz, 18.5 dB gain push-pull amplifier

BGY1085A

CHARACTERISTICS

Table 1 Bandwidth 40 to 1 000 MHz; $T_{\text{case}} = 30\text{ }^{\circ}\text{C}$; $Z_S = Z_L = 75\ \Omega$

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
G_p	power gain	f = 50 MHz	18	–	19	dB
		f = 1 000 MHz	18.5	–	–	dB
SL	slope cable equivalent	f = 40 to 1 000 MHz	0	–	2	dB
FL	flatness of frequency response	f = 40 to 1 000 MHz	–	–	± 0.3	dB
S_{11}	input return losses	f = 40 to 80 MHz	20	–	–	dB
		f = 80 to 160 MHz	18.5	–	–	dB
		f = 160 to 320 MHz	17	–	–	dB
		f = 320 to 640 MHz	15.5	–	–	dB
		f = 640 to 1 000 MHz	14	–	–	dB
S_{22}	output return losses	f = 40 to 80 MHz	20	–	–	dB
		f = 80 to 160 MHz	18.5	–	–	dB
		f = 160 to 320 MHz	17	–	–	dB
		f = 320 to 640 MHz	15.5	–	–	dB
		f = 640 to 1 000 MHz	14	–	–	dB
CTB	composite triple beat	85 channels flat; $V_o = 44\text{ dBmV}$; measured at 595.25 MHz	–	–	–58	dB
		110 channels flat; $V_o = 44\text{ dBmV}$; measured at 745.25 MHz	–	–	–53	dB
		150 channels flat; $V_o = 40\text{ dBmV}$; measured at 985.25 MHz	–	–53	–	dB
X_{mod}	cross modulation	85 channels flat; $V_o = 44\text{ dBmV}$; measured at 55.25 MHz	–	–	–58	dB
		110 channels flat; $V_o = 44\text{ dBmV}$; measured at 55.25 MHz	–	–	–54	dB
		150 channels flat; $V_o = 40\text{ dBmV}$; measured at 55.25 MHz	–	–54	–	dB
CSO	composite second order distortion	85 channels flat; $V_o = 44\text{ dBmV}$; measured at 596.5 MHz	–	–	–60	dB
		110 channels flat; $V_o = 44\text{ dBmV}$; measured at 746.5 MHz	–	–	–56	dB
		150 channels flat; $V_o = 40\text{ dBmV}$; measured at 986.5 MHz	–	–56	–	dB

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BGY1085A

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
d_2	second order distortion	note 1	–	–	–72	dB
		note 2	–	–	–65	dB
		note 3	–	–68	–	dB
V_o	output voltage	$d_{im} = -60$ dB				
		note 4	61	–	–	dBmV
		note 5	60	–	–	dBmV
		note 6	57	–	–	dBmV
F	noise figure	f = 50 MHz	–	–	5.5	dB
		f = 550 MHz	–	–	6	dB
		f = 600 MHz	–	–	6	dB
		f = 650 MHz	–	–	6.5	dB
		f = 750 MHz	–	–	7	dB
		f = 860 MHz	–	–	7.5	dB
		f = 1 000 MHz	–	–	7.5	dB
I_{tot}	total current consumption (DC)	note 7	–	–	240	mA

Notes

- $f_p = 55.25$ MHz; $V_p = 44$ dBmV;
 $f_q = 541.25$ MHz; $V_q = 44$ dBmV;
measured at $f_p + f_q = 596.5$ MHz.
- $f_p = 55.25$ MHz; $V_p = 44$ dBmV;
 $f_q = 691.25$ MHz; $V_q = 44$ dBmV;
measured at $f_p + f_q = 746.5$ MHz.
- $f_p = 55.25$ MHz; $V_p = 40$ dBmV;
 $f_q = 931.25$ MHz; $V_q = 40$ dBmV;
measured at $f_p + f_q = 986.5$ MHz.
- $f_p = 590.25$ MHz; $V_p = V_o$;
 $f_q = 597.25$ MHz; $V_q = V_o - 6$ dB;
 $f_r = 599.25$ MHz; $V_r = V_o - 6$ dB;
measured at $f_p + f_q - f_r = 588.25$ MHz.
- $f_p = 740.25$ MHz; $V_p = V_o$;
 $f_q = 747.25$ MHz; $V_q = V_o - 6$ dB;
 $f_r = 749.25$ MHz; $V_r = V_o - 6$ dB;
measured at $f_p + f_q - f_r = 738.25$ MHz.
- $f_p = 980.25$ MHz; $V_p = V_o$;
 $f_q = 987.25$ MHz; $V_q = V_o - 6$ dB;
 $f_r = 989.25$ MHz; $V_r = V_o - 6$ dB;
measured at $f_p + f_q - f_r = 978.25$ MHz.
- The module normally operates at $V_B = 24$ V, but is able to withstand supply transients up to 30 V.

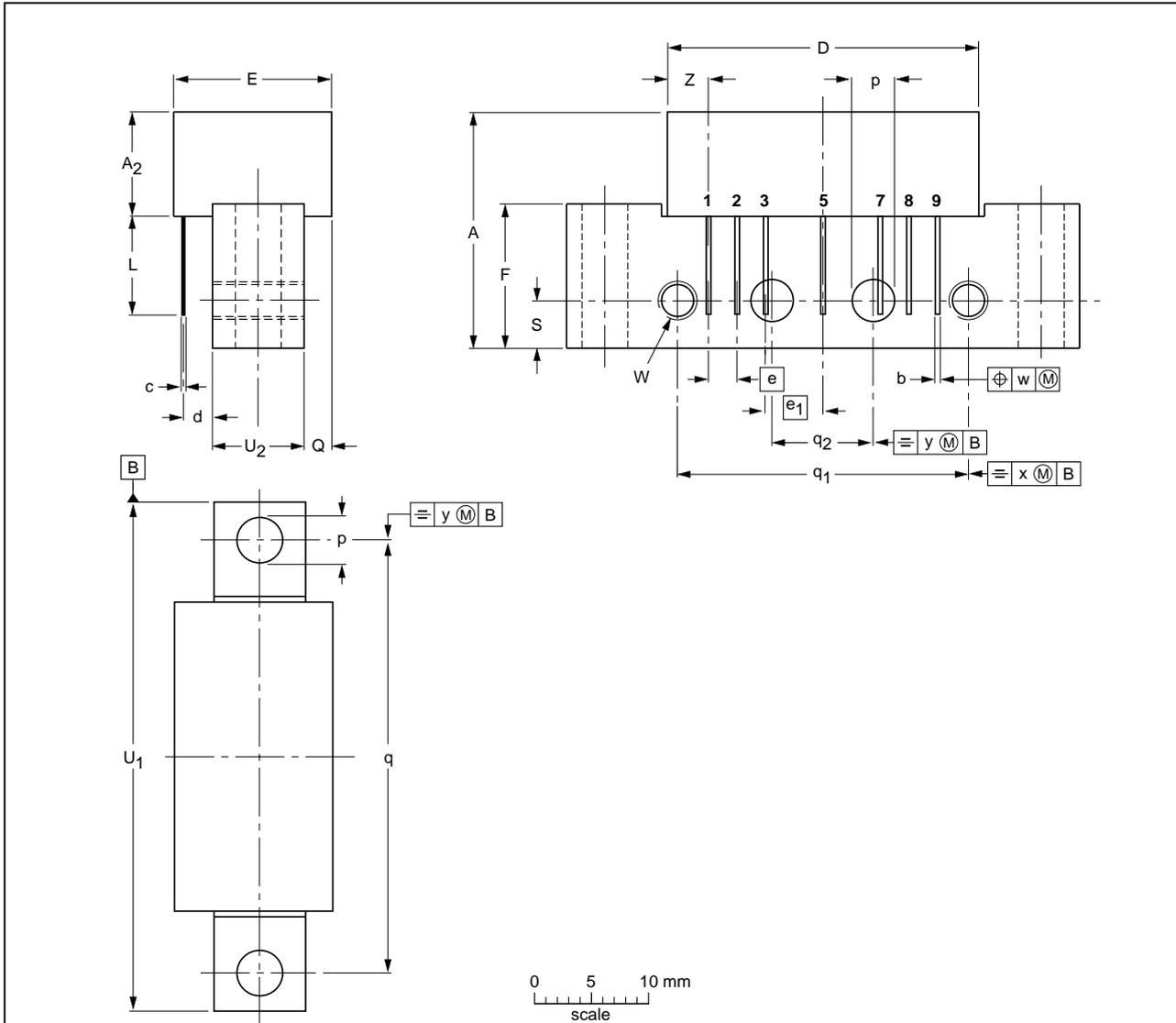
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BGY1085A

PACKAGE OUTLINE

Rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 x 6-32 UNC and 2 extra horizontal mounting holes; 7 gold-plated in-line leads

SOT115J



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A ₂ max.	b	c	D max.	d	E max.	e	e ₁	F	L min.	p	Q max.	q	q ₁	q ₂	S	U ₁	U ₂	W	w	x	y	Z max.
mm	20.8	9.5	0.51 0.38	0.25	27.2	2.04 2.54	13.75	2.54	5.08	12.7	8.8	4.15 3.85	2.4	38.1	25.4	10.2	4.2	44.75 44.25	8.2 7.8	6-32 UNC	0.25	0.7	0.1	3.8

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT115J						04-02-04 10-06-18

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BGY1085A

DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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BGY1085A

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